REV LETTER: F PAGE NO: 1 OF 1 PART NUMBER:

# Polymer PTC Devices

Surface mount fuses

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# **Features**

LP-ISM035

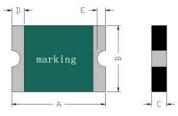
- □ Small size of 0805
- □ Lead-free and compliant with the European Union RoHS Directive 2002/95/EC
- ☐ Fast tripping resettable circuit protection
- □ Surface mount packaging for automated assembly
- □ Agency Recognition: UL pending





# Product Dimensions (mm)

Part number -	Α	В	С	D	E	- Part marking	
	Max.	Max.	Max.	Min.	Min.		
LP-ISM035	2.20	1.50	0.75	0.10	0.20	3	



Top View

Side View

# **Electrical Characteristics**

Part number -	l <sub>Η</sub>	Ι <sub>Τ</sub>	$V_{max}$	I <sub>max</sub>	$T_{trip}$		Pd <sub>typ</sub>	$R_{min}$	R <sub>1max</sub>
	(A)	(A)	(V)	(A)	Current(A)	Time(S)	(W)	<b>(Ω)</b>	(Ω)
LP-ISM035	0.35	0.75	6.00	40.0	8.00	0.10	0.5	0.25	1 20

I<sub>H</sub>=Hold current: maximum current at which the device will not trip at 25°C still air.

I<sub>T</sub>=Trip current: minimum current at which the device will always trip at 25℃ still air.

V<sub>max</sub>=Maximum voltage device can withstand without damage at rated current.

I<sub>max</sub>=Maximum fault current device can withstand without damage at rated voltage.

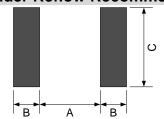
T<sub>trip</sub>=Maximum time to trip(s) at assigned current.

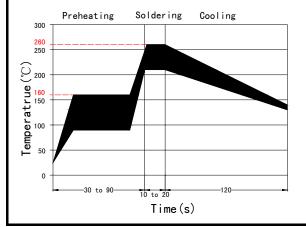
Pd<sub>typ</sub>=Typical power dissipation: typical amount of power dissipated by the device when in state air environment.

R<sub>min</sub>=Minimum device resistance at 25℃ prior to tripping.

 $R_{1\text{max}}$ =Maximum device resistance measured in the nontripped state 1 hour post reflow.

# **Solder Reflow Recommendations**





# Solder Pad Layouts Part number A B C (mm) (mm) (mm) LP-ISM035 1.20 1.00 1.50

- \* Recommended reflow methods: IR, Vapor phase, hot air oven.
- \* Devices can be cleaned using standard industry methods and solvents.

#### Notes:

- If reflow temperatures exceed the recommended profile, devices may not meet the performance requirements.
- Devices are not designed to be wave soldered to the bottom side of the board.

### **Package Information**

Tape & Reel: 5000pcs per reel.

Effectivity: Reference documents shall be the issue in effect on the date of invitation for bid.

Caution: Operation beyond the rated voltage or current may result in rupture electrical arcing or flame.